■ Lighting Color

Amber

LNJ418Q8YRU

Surface Mounting Chip LED

Dome-Lens FD Type

■ Absolute Maximum Ratings $T_a = 25$ °C

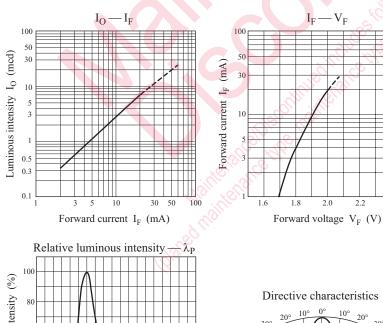
Parameter	Symbol	Rating	Unit		
Power dissipation	P_{D}	60	mW		
Forward current	I_{F}	20	mA		
Pulse forward current *	I_{FP}	60	mA		
Reverse voltage	V _R	4	V		
Operating ambient temperature	T _{opr}	-30 to +85	°C		
Storage temperature	T _{stg}	-40 to +100	°C		

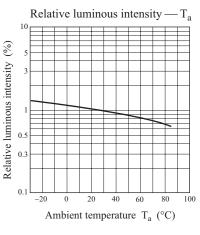
Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

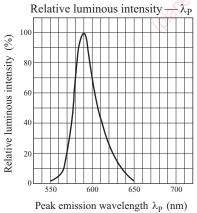
■ Electro-Optical Characteristics $T_a = 25$ °C±3°C

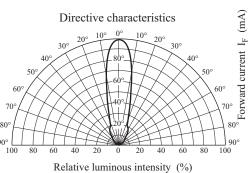
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity *	I _O	$I_F = 20 \text{ mA}$	3.7	7.0	50	mcd
Reverse current	I_R	$V_R = 4 V$	111	200,	10	μΑ
Forward voltage	V _F	$I_F = 20 \text{ mA}$	dillo	2.0	2.6	V
Peak emission wavelength	$\lambda_{ m P}$	$I_F = 20 \text{ mA}$	" IN THE	590		nm
Spectral half band width	Δλ	$I_F = 20 \text{ mA}$	OUL	30		nm

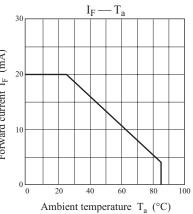
Note) *: Measurement tolerance: ±20%







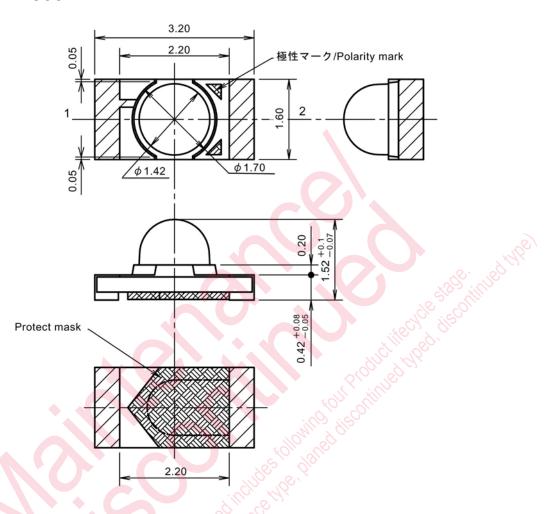




LNJ418Q8YRU Panasonic

■ Package (Unit: mm)

KLTLTN2K1800



- Pin name
 - 1: Anode
 - 2: Cathode

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